IPC ASSOCIATION C ELECTRONICS II	© Copyright 2005. IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bot international and Pan-American copyright conventions.		This docum level parts,			es within the manufactur wer level materials for w					
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Info				n			
upplier I	Information											
Company name* Company unique ID				Unique ID Authority			Response Date*					
nsemi									2024-09-25			
Contact Name Title - Contact			act		Phone - Contact*			Email - Contact*				
Product-Env-Stewards Prod			Product Enviro Compliance		NA NA			Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representat			esentative	Phone - Representative* Email - Represent			Email - Representat	ive*				
Product-Env-Stewards Product Enviro Compliance			viro Compliance		NA			Product-Env-Stewards@onsemi.com				
F	Requester Item Number	Mfr Item Number	Number Mfr Item Name		Effective Date Version Manufacturing Signature		Manufacturing Site	Weight*	UOM	Unit Type		
		NXH240B120H3Q1P G	PIM Q1 3 Channel IO 1200V Press-fit pins	GBT+SiC Boost 240A	2024-09-25		CNG	41398.5	mg	Each		
lanufact	curing Proccess Information	on										
Т	Terminal Plating / Grid Array Material Termina		Alloy J-S7	ΓD-020 MSL Rating	Peak Process Body Temperature Max Time at		ture Max Time at Peak	Temperature Numbe	r of Reflow Cy	cles		
M	Matte Tin (Sn) - annealed		CU Alloy NA		0 C 30		30	seconds 3				

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	17500.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		6125	mg
			Supplier	PBT	26062-94-2		11375	mg
DBC	13654.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		4586.3789	mg
			Supplier	Copper (Cu)	7440-50-8		9067.6211	mg
Die	133.2	mg	Supplier	Silicon Carbide	409-21-2		133.2	mg
			Supplier	Silicon (Si)	7440-21-3		0	mg
Die Attach Solder	500.0	mg	Supplier	Dimethyl phthalate	131-11-3		5	mg
			Supplier	Amines	61788-95-2		5	mg
			Supplier	Isotridecan-1-ol	27458-92-0		5	mg
			Supplier	Silver (Ag)	7440-22-4		20	mg
			Supplier	Tin (Sn)	7440-31-5		465	mg
Glue	3600.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		360	mg
			Supplier	Miscellaneous	Trade Secret		360	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		2880	mg
Plating	15.5	mg	Supplier	Tin (Sn)	7440-31-5		15.5	mg
Pressfit Terminal	122.8	mg	Supplier	Silicon (Si)	7440-21-3		0.307	mg
			В	Nickel (Ni)	7440-02-0		0.221	mg
			Supplier	Copper (Cu)	7440-50-8		122.2351	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0368	mg
Silicone Gel	5740.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		1722.0001	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		4018	mg
Thermistor	38.5	mg	Supplier	Tin (Sn)	7440-31-5		0.4813	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		0.0578	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.0616	mg
			В	Nickel (Ni)	7440-02-0		8.9897	mg
			Supplier	Gold (Au)	7440-57-5		0.0077	mg
			Supplier	Iron (Fe)	7439-89-6		9.625	mg
			A	Lead Oxide (PbO)	1317-36-8		8.8242	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.0578	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		0.0578	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		0.7469	mg

			Supplier	Copper (Cu)	7440-50-8	4.2543	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7	5.3361	mg
Wire Bond - Al	94.5	mg	В	Nickel (Ni)	7440-02-0	0.0047	mg
			Supplier	Aluminum (Al)	7429-90-5	94.4953	mg